

S-UM6532 LOW CHARGE INJECTION 64-CHANNEL 6Ω HIGH-VOLTAGE ANALOG SWITCHES

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The ABLIC S-UM6532 is a low charge injection 64-channel single-pole single-throw (SPST) high-voltage analog switch IC operated only by a single 5V for ultrasound imaging applications. The S-UM6532 has ± 100 V analog signal range allowing ± 150 V voltage overshoot.

■ Function

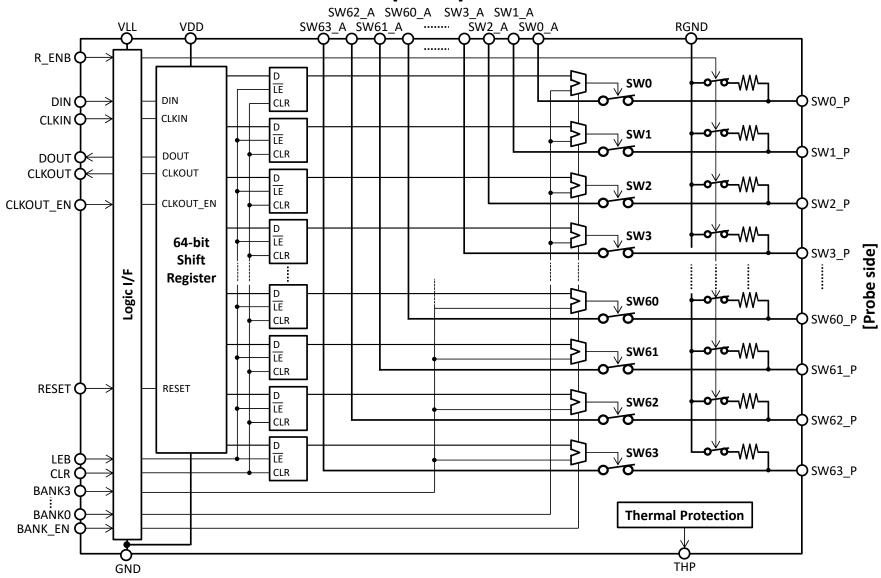
64-channel high-voltage SPST analog switches with user-selectable logic interface and bleed resistor

■ Features

- 0V to ±100V analog signal voltage range allowing ±150V voltage overshoot
- 10kHz to 70MHz analog signal frequency range
- 2A peak analog signal current per channel
- 6Ω switch on-resistance
- Single +5V power supply (NO HIGH-VOLTAGE POWER SUPPLY required)
- User-selectable Serial Digital Interface (64-bit shift registers) or Bank Interface (4 banks of 16-channel)
- User-selectable 40kΩ bleed resistor on probe side
- Low on/off-capacitance
- 15pC charge injection to 1000pF
- -75dB off-isolation at analog small-signal 5MHz
- -60dB switch crosstalk
- 1.8V to 5V CMOS logic interface
- Low power dissipation (static 5mW)
- Embedded thermal protection with flag indicator
- RoHS compliant 15x15mm BGA package

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■ Absolute Maximum Ratings

 T_A =25°C unless otherwise noted.

No.	Items	Symbol	Value	Units	Condition
1	Positive logic supply voltage	V_{LL}	-0.4 to +7	V	
2	Positive supply voltage	V _{DD}	-0.4 to +7	V	
3	Logic input voltage	DIN, CLKIN, RESET, CLR, LEB, BANK0, BANK1, BANK2, BANK3, BANK_EN, CLKOUT_EN, R_ENB	-0.4 to +7	V	
4	Logic output voltage	DOUT, CLKOUT, THP	-0.4 to +7	V	
5	Analog signal range (steady state voltage)	V_{SIG}	-105 to +105	V	
6	Analog signal range (peak overshoot voltage)	V_{SIG_OS}	-150 to +150	V	Max. 500ns pulse width
7	Peak analog signal current per channel	I _{sw}	2	А	
8	Operating junction temperature	T _{Jop}	-20 to +150	°C	
9	Storage temperature	T _{STG}	-55 to +150	°C	
10	Maximum power dissipation	P _{Dmax}	4	W	

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■ Operating Supply Voltages, Temperature, Logic Levels

T_A=25°C unless otherwise noted.

_A =25	5°C unless otherwise noted.					i	
No.	Items	Symbol	Min	Тур	Max	Units	Condition
1	Logic supply voltage	V _{LL}	1.7	1.8 to 5	V_{DD}	V	
2	Positive supply voltage	V _{DD}	4.75	5	5.25	V	
3	Operating free-air temperature	T _A	0	-	75	°C	
4	High-level logic input voltage	V _{IH}	$0.8V_{LL}$	-	V_{LL}	V	
5	Low-level logic input voltage	V _{IL}	0	-	0.2V _{LL}	V	
6	High-level logic output voltage	V _{OH}	$0.8V_{LL}$	-	-	V	I _{SOURCE} =1mA
7	Low-level logic output voltage	V _{OL}	-	-	0.2V _{LL}	V	I _{SINK} =1mA
8	Logic input high current *1)	I _{IH}	-10	-	10	μA	DIN, CLKIN, RESET, CLR, LEB, BANKO,
9	Logic input low current	I _{IL}	-10	-	10	μA	BANK1, BANK2, BANK3, BANK_EN,
10	Logic input capacitance	C _{IN}	-	2	-	pF	CLKOUT_EN, R_ENB
			=	-	50	MHz	CLKOUT_EN=0,V _{LL} =1.8V
			-	-	80	MHz	CLKOUT_EN=0,V _{LL} =2.5V
4.4	Clark framus and		-	-	95	MHz	CLKOUT_EN=0,V _{LL} =3.3V
11	Clock frequency	f _{CLK}	-	-	60	MHz	CLKOUT_EN=1,V _{LL} =1.8V
			-	-	85	MHz	CLKOUT_EN=1,V _{LL} =2.5V
			-	-	130	MHz	CLKOUT_EN=1,V _{LL} =3.3V
12	Clock rise and fall times	t _{R,} t _F	-	-	50	ns	
13	CLKIN to DOUT delay	t _{DO}	7	10	24	ns	
14	CLKOUT to DOUT delay	t _{DO1}	1.3	-	1.9	ns	
15	CLKIN to CLKOUT delay	t _{DCKO}	7	10	24	ns	
16	DIN to CLKIN setup time	t _{SU}	1	-	-	ns	
17	DIN to CLKIN hold time	t _{HD}	2	-	-	ns	
18	LEB setup time	t _{SLEB}	5	-	-	ns	
19	LEB low-pulse width	t _{WLEB}	12	-	-	ns	
20	CLR response time	t _{DCLR}	=	-	500	ns	
21	CLR high-pulse width	t _{wclr}	12	-	-	ns	
22	Bank interface setup time	t _{SBNK}	100	-	-	ns	
23	Bank interface hold time	t _{HBNK}	1	-	-	us	
24	BANKx minimum pulse width	t _{wbnk}	4	-	-	us	
25	RESET response time	t _{DRST}	-	-	400	ns	
26	RESET high-pulse width	t _{wrst}	12	-	-	ns	

NOTE: *1) BANK_EN, CLKOUT_EN, and R_ENB have 100 μ A leakage at V_{LL}=5V due to 50k Ω internal pull-down resistor.

■ Power Supply Sequencing

No power supply sequencing is required even if V_{LL} is different from V_{DD} . Please apply the V_{DD} voltage to the V_{LL} when operating with a single 5V.

■ DC Characteristics

 V_{LL} =3.3V, V_{DD} =5V, LEB=0, T_A =25°C, unless otherwise specified.

No.	Items	Symbol		Spec		Units	Conditions
INO.	items	Syllibol	Min	Тур	Max	Ullits	Conditions
1	Analog signal range (steady state voltage)	V _{SIG}	-100	-	+100	V	
2	Analog signal range (peak overshoot voltage)	V _{SIG_OS}	-150	-	+150	V	Max. 500ns pulse width
3	V _{LL} quiescent current	I _{LLQ}	-	0.2	-	μA	Quiescent current-1
4	V _{DD} quiescent current	I _{DDQ}	-	4.3	-	mA	All switches off
5	V _{LL} quiescent current	I _{LLQ}	-	0.2	-	μA	Quiescent current-2
6	V _{DD} quiescent current	I _{DDQ}	-	4.3	-	mA	All switches on
7	V _{LL} dynamic current	I _{LL}	-	2	10	μA	Dynamic current
8	V _{DD} dynamic current	I _{DD}	-	9	11	mA	All channels switching simultaneously at f _{sw} =50kHz
9	DC offset switch off	Vos	-	0	-	mV	
10	Small signal switch on-resistance	R _{ONS}	-	6	8	Ω	V_{SIG} =0.1Vpp to 5Vpp @5MHz, R _S =10 Ω
11	Small signal switch on-resistance matching	ΔR _{ONS}	-	2	5	%	V _{SIG} =0V, I _{SIG} =5mA
12	Large signal switch on-resistance	R _{ONL}	-	6	-	Ω	V_{SIG} =20Vpp@5MHz, R _S =10 Ω
13	Bleed resistance	R _{BLD}	30	40	50	kΩ	R_ENB=0, probe side only
14	Switch output peak current	I _{SW}	-	2	-	Α	100ns pulse, 0.1% duty cycle

■ Thermal Protection Characteristics

 V_{LL} =3.3V, V_{DD} =5V, LEB=0, T_A =25°C, unless otherwise specified.

No.	Items	Symbol		Spec		Units	Conditions		
INO.	items	Symbol	Min	Тур	Max	UTILS	Conditions		
1	THP pull-up voltage	V _{PUTHP}	-	-	5.25	V	Open drain		
2	THP output current	I _{THP}	-	1.0	-	mA	-		
3	THP output low voltage	V _{OLTHP}	-	-	0.5	V	THP active, V _{LL} =3.3V, I _{THP} =1mA		
4	THP temperature threshold	T _{THP}	90	110	130	°C	Thermal protection flag indicator by THP pin (open N-MOS drain, Low=THP activating)		
5	THP reset hysteresis	T _{HYSTHP}	-	10	-	°C			

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■ AC Characteristics

 $\rm V_{LL}$ =3.3V, $\rm V_{DD}$ =5V, LEB=0, $\rm T_A$ =25°C, unless otherwise specified.

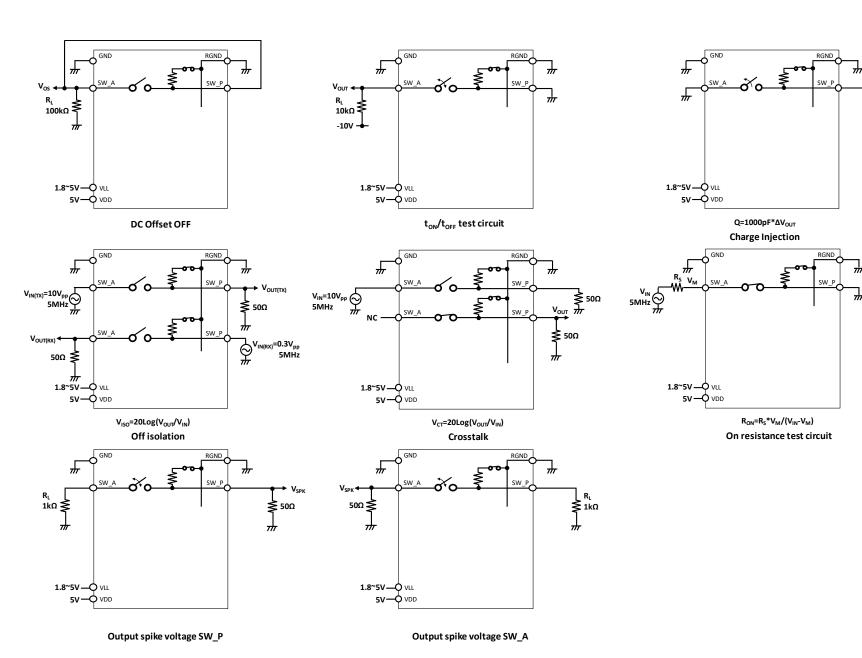
No.	Iten	ne	Symbol		Spec		Units	Conditions
140.	iton	113	Cymbol	Min	Тур	Max	Office	Conditions
1	Turn-on time		t _{ON}	-	2	4	μs	BANK_EN=0
'	Turn-on time		t _{ON_BNK}	-	2	4	μs	BANK_EN=1
2	Turn-off time		t _{OFF}	-	2	4	μs	BANK_EN=0
-	Turri-on time		t _{OFF_BNK}	-	2	4	μs	BANK_EN=1
3	Output switching	frequency	f _{SW}	-	-	50	kHz	Duty cycle=50%
4	Small signal frequ	mall signal frequency		0.01	-	70	MHz	C _L =220pF
5	Off icolation	f isolation small signal		-	-75	-	dB	f_{SIG} =5MHz, R_L =50 Ω
3	Oli isolation	large signal		-	-60	-	dB	f_{SIG} =5MHz, R_L =50 Ω
6	Crosstalk	•	V _{ISO(TX)} V _{CT}	-	-60	-	dB	f_{SIG} =5MHz, R_L =50 Ω
7	On capacitance	small signal	C _{ON(RX)}	-	27	-	pF	V _{SIG} =0V, f _{SIG} =1MHz
′	On capacitance	large signal	C _{ON(TX)}	-	27	-	pF	V _{SIG} =10Vpp, f _{SIG} =1MHz
8	Off capacitance SW_P to GND	small signal	C _{OFF(SWP_RX)}	-	18	-	pF	V _{SIG} =0V, f _{SIG} =1MHz
9	Off capacitance SW_A to GND	small signal	C _{OFF(SWA_RX)}	-	14	-	pF	V _{SIG} =0V, f _{SIG} =1MHz
"	SW_A to GND	large signal	C _{OFF(SWA_TX)}	-	16	-	pF	V _{SIG} =10Vpp, f _{SIG} =1MHz
10	Output spike volte	ngo (SW/ D)	V _{SPK_ON(SWP)}	-	30	-	mV	50Ω load @switch on
'0	Output spike voltage (SW_P)		V _{SPK_OFF(SWP)}	-	60	-	mV	50Ω load @switch off
11	Output onike veltage (CM/ A)		V _{SPK_ON(SWA)}	-	30	-	mV	50Ω load @switch on
''	Output spike voltage (SW_A)		V _{SPK_OFF(SWA)}	-	60	-	mV	50Ω load @switch off
12	Charge injection		QC	-	15	-	рC	

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 ΔV_{OUT}

1000pF

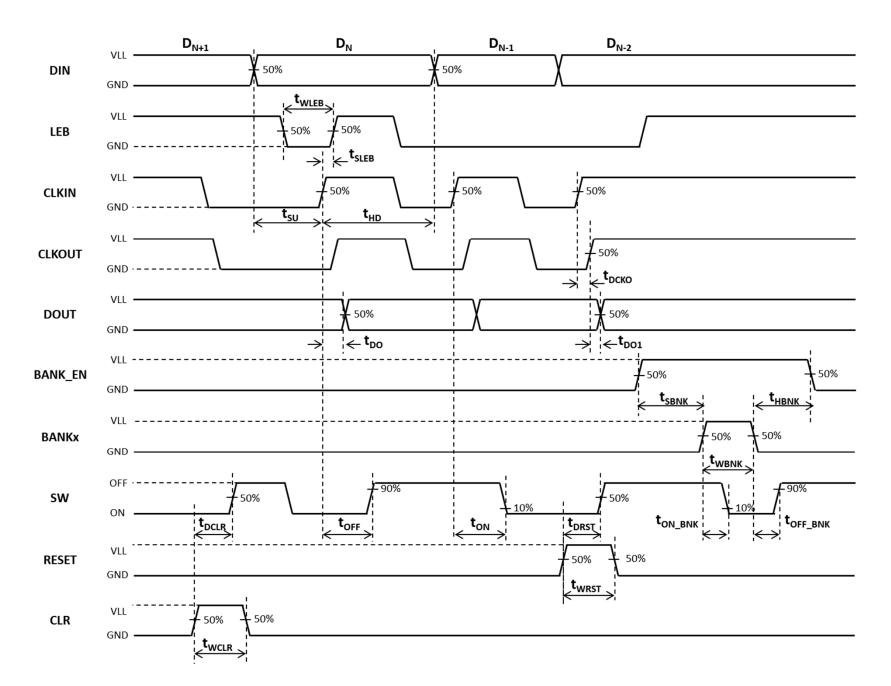
■ Test Circuits



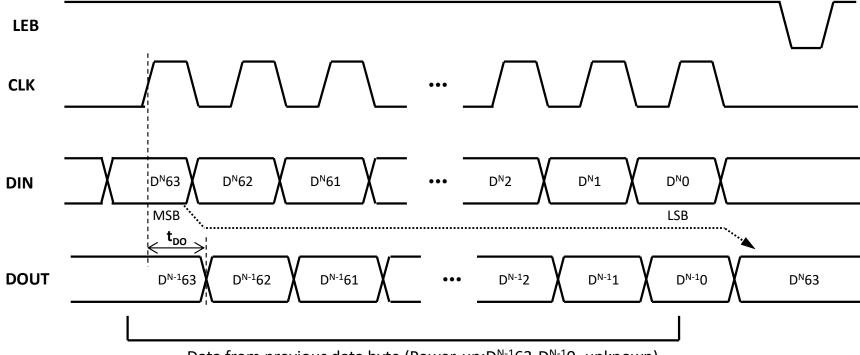
■ Truth Table

	Logic Inputs													Δn	alog Sv	vitch St	ato														
RESET	LEB	CLR	BANK	DANIZO	DANK1	BANK2	D VVII/ 3							IN										~!·	alog ov	vitori ot	ate				
RESET	LED	CLK	_EN	DAINNU	DAINK	DAINNZ	DAINNS	D0		D15	D16		D31	D32		D47	D48		D63	SW0		SW15	SW16		SW31	SW32		SW47	SW48		SW63
L	L	L	L	X	X	X	Х	L		-	-		-	-		-	-		-	OFF		-	-		-	-		-	-		-
L	L	L	L	X	Х	Х	Х	Н		-	-		-	-		-	-		-	ON		-	-		-	-		-	-		
L	L	L	L	X	X	Х	Х	-		L	-		-	-		-	-		-	-		OFF	-		-	-		-	-		-
L	L	L	L	Х	Х	Х	Х	-		Н	-		-	-		-			-	-		ON	-		-	-	1	-	-		-
L	L	L	L	Х	Х	Х	Х	-		-	L		-	-		-	-		-	-		-	OFF		-	-		-	-		-
L	L	L	L	Х	Х	Х	Х	-		-	Н		-	-		-	-		-	-		-	ON		-	-		-	-	l i	-
L	L	L	L	Х	Х	Х	Х	-		-	-		L	-		-	-		-	-		-	-		OFF	-		-	-	1	-
L	L	L	L	Х	Х	Х	Х	-		-	-		Н	-		-	-		-	-		-	-		ON	-		-	-	1	-
L	L	L	L	Х	Х	Х	Х	-	Ī · · · ·	-		• • • •	-	L		-	-		-	-		-	-		-	OFF		-	-		-
L	L	L	L	Х	Х	Х	Х	-		-	-		-	Н		-	-		-	-		-	-		-	ON		-	-	1 1	-
L	L	L	L	Х	Х	Х	Х	-	1	-	-		-	-		L	-		-	-		-	-		-	-		OFF	-		-
L	L	L	L	Х	Х	Х	Х	-	1	-	-		-	-		Н	-		-	-		-	-		-	-		ON	-	1 1	-
L	L	L	L	Х	Х	Х	Х	-	1	-	-		-	-		-	L		-	-		-	-		-	-		-	OFF	1 1	-
L	L	L	L	Х	Х	Х	Х	-		-	-		-	-	İ	-	Н		-	-		-	-		-	-	1	-	ON		-
L	L	L	L	Х	Х	Х	Х	-		-	-		-	-	1	-	-		L	-		-	-		-	-	1	-	-		OFF
L	L	L	L	Х	Х	Х	Х	-		-	-		-	-	1	-	-		Н	-		-	-		-	-	1	-	-		ON
L	Н	L	L	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х					ŀ	Hold Prev	ious Stat	е				
L	Х	Н	L	Х	Х	Х	Х	Х	Х	Х	Х	Х	Χ	Х	Х	Х	Х	Х	Х						ALL SV	Vs OFF					
Н	Н	L	L	Х	Х	Х	Х	L	L	L	L	L	L	L	L	L	L	L	L					ŀ	Hold Prev	ious Stat	е				
Н	L	L	L	Х	Х	Х	Х	L	L	L	L	L	L	L	L	L	L	L	L							Vs OFF					
Х	Х	Х	Н	Н	L	L	L	Х	Х	Х	Х	Х	Х	X	Х	Х	Х	Х	Х			15 ON	SW16-					47 OFF	SW48		
Х	Х	Х	Н	L	Н	L	L	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	SW0~SW15 OFF											
X	Х	Х	Н	L	L	Н	L	Х	Х	Х	Х	Х	Х	X	Х	Х	Х	Х	Х			5 OFF	SW16~			SW32			SW48		
Х	Χ	Х	Н	L	L	L	Н	X	Х	Х	Х	Х	Х	X	Х	Х	Х	Х	X	SW0~	SW1	5 OFF	SW16-	~SW	31 OFF	SW32	~SW	47 OFF	SW48	~SW	33 ON

■ Logic Timing



■ Latch Enable Interface Timing



■ Pin Description

Pin Name	I/O	Function
VLL	-	Positive voltage supply of low voltage interface (+1.8V~+5V)
VDD	-	Positive low voltage power supply (+5V)
GND	-	Drive power ground (0V)
RGND	-	Bleed resistor ground (0V)
DIN	I	Serial-Data input
DOUT	0	Serial-Data output
CLKIN	I	Serial-Clock input
CLKOUT	0	Serial-Clock output
LEB	I	Active-Low latch enable input, Hi=Hold data, Low=Latch data input
BANK0	I	Bank-Data input 0 for SW0 to SW15, Hi=ON, Low=OFF
BANK1	I	Bank-Data input 1 for SW16 to SW31, Hi=ON, Low=OFF
BANK2	I	Bank-Data input 2 for SW32 to SW47, Hi=ON, Low=OFF
BANK3	I	Bank-Data input 3 for SW48 to SW63, Hi=ON, Low=OFF
RESET	I	Shift register reset input
CLR	I	Latch clear input
CLKOUT_EN	I	Clock out enable input, Hi=Clock out, Low=Disable (Low)
R_ENB	I	Bleed resistor enable input, Hi=Disable, Low=Enable
BANK_EN	I	Bank interface enable input, Hi=Bank-Data interface, Low=Serial-Data interface
THP	0	Thermal protection output flag, open N-MOS drain (Low=THP activating)
SWx_A	I/O	Analog switch terminal n (AFE side), Suffix "x" corresponds to channel number (x=0 to 63)
SWx_P	I/O	Analog switch terminal n (Probe side), Suffix "x" corresponds to channel number (x=0 to 63)
NC	-	No connection (Not internally connected)

LOW CHARGE INJECTION 64-CHANNEL 6Ω HIGH-VOLTAGE ANALOG SWITCHES S-UM6532

■ Pin Configuration (Table)

No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name
A1	DIN	B1	CLKIN	C1	VLL	D1	SW63_A	E1	NC	F1	SW61_A
A2	LEB	B2	RESET	C2	VDD	D2	NC	E2	SW62_A	F2	NC
A3	GND	B3	GND	C3	RGND	D3	SW63_P	E3	NC	F3	SW61_P
A4	SW0_A	B4	NC	C4	SW0_P	D4	NC	E4	SW62_P	F4	NC
A5	NC	B5	SW1_A	C5	NC	D5	SW1_P	E5	NC	F5	NC
A6	SW2_A	B6	NC	C6	SW2_P	D6	NC	E6	NC	F6	NC
A7	NC	B7	SW3_A	C7	NC	D7	SW3_P	E7	NC	-	-
A8	SW4_A	B8	NC	C8	SW4_P	D8	NC	E8	NC	-	-
A9	NC	B9	SW5_A	C9	NC	D9	SW5_P	E9	NC	-	-
A10	SW6_A	B10	NC	C10	SW6_P	D10	NC	E10	NC	-	-
A11	NC	B11	SW7_A	C11	NC	D11	SW7_P	E11	NC	-	-
A12	SW8_A	B12	NC	C12	SW8_P	D12	NC	E12	NC	-	-
A13	NC	B13	SW9_A	C13	NC	D13	SW9_P	E13	NC	-	-
A14	SW10_A	B14	NC	C14	SW10_P	D14	NC	E14	NC	-	-
A15	NC	B15	SW11_A	C15	NC	D15	SW11_P	E15	NC	-	-
A16	SW12_A	B16	NC	C16	SW12_P	D16	NC	E16	NC	-	-
A17	NC	B17	SW13_A	C17	NC	D17	SW13_P	E17	NC	-	-
A18	SW14_A	B18	NC	C18	SW14_P	D18	NC	E18	SW16_P	F18	NC
A19	NC	B19	SW15_A	C19	NC	D19	SW15_P	E19	NC	F19	SW18_P
A20	VLL	B20	NC	C20	RGND	D20	NC	E20	SW17_P	F20	NC
A21	GND	B21	THP	C21	GND	D21	SW16_A	E21	NC	F21	SW18_A
A22	DOUT	B22	CLKOUT	C22	VDD	D22	NC	E22	SW17_A	F22	NC

No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name
G1	NC	H1	SW59_A	J1	NC	K1	SW57_A	L1	NC	M1	SW55_A
G2	SW60_A	H2	NC	J2	SW58_A	K2	NC	L2	SW56_A	M2	NC
G3	NC	H3	SW59_P	J3	NC	K3	SW57_P	L3	NC	M3	SW55_P
G4	SW60_P	H4	NC	J4	SW58_P	K4	NC	L4	SW56_P	M4	NC
G5	NC	H5	NC	J5	NC	K5	NC	L5	NC	M5	NC
-	-	-	-	-	-	-	-	-	-	-	-
G7	GND	H7	GND	J7	GND	K7	GND	L7	GND	M7	GND
G8	GND	H8	GND	J8	GND	K8	GND	L8	GND	M8	GND
G9	GND	H9	GND	J9	GND	K9	GND	L9	GND	M9	GND
G10	GND	H10	GND	J10	GND	K10	GND	L10	GND	M10	GND
G11	GND	H11	GND	J11	GND	K11	GND	L11	GND	M11	GND
G12	GND	H12	GND	J12	GND	K12	GND	L12	GND	M12	GND
G13	GND	H13	GND	J13	GND	K13	GND	L13	GND	M13	GND
G14	GND	H14	GND	J14	GND	K14	GND	L14	GND	M14	GND
G15	GND	H15	GND	J15	GND	K15	GND	L15	GND	M15	GND
G16	GND	H16	GND	J16	GND	K16	GND	L16	GND	M16	GND
-	-	-	-	-	1	-	1	-	1	-	-
G18	NC	H18	NC	J18	NC	K18	NC	L18	NC	M18	NC
G19	NC	H19	SW20_P	J19	NC	K19	SW22_P	L19	NC	M19	SW24_P
G20	SW19_P	H20	NC	J20	SW21_P	K20	NC	L20	SW23_P	M20	NC
G21	NC	H21	SW20_A	J21	NC	K21	SW22_A	L21	NC	M21	SW24_A
G22	SW19 A	H22	NC	J22	SW21 A	K22	NC	L22	SW23 A	M22	NC

■ Pin Configuration (Table)

No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name
N1	NC	P1	SW53_A	Q1	NC	R1	SW51_A	S1	NC
N2	SW54_A	P2	NC	Q2	SW52_A	R2	NC	S2	SW50_A
N3	NC	P3	SW53_P	Q3	NC	R3	SW51_P	S3	NC
N4	SW54_P	P4	NC	Q4	SW52_P	R4	NC	S4	SW50_P
N5	NC	P5	NC	Q5	NC	R5	NC	S5	NC
-	-	-	-	-	-	-	ı	-	-
N7	GND	P7	GND	Q7	GND	R7	GND	-	-
N8	GND	P8	GND	Q8	GND	R8	GND	-	-
N9	GND	P9	GND	Q9	GND	R9	GND	-	-
N10	GND	P10	GND	Q10	GND	R10	GND	-	-
N11	GND	P11	GND	Q11	GND	R11	GND	-	-
N12	GND	P12	GND	Q12	GND	R12	GND	-	-
N13	GND	P13	GND	Q13	GND	R13	GND	-	-
N14	GND	P14	GND	Q14	GND	R14	GND	-	-
N15	GND	P15	GND	Q15	GND	R15	GND	-	-
N16	GND	P16	GND	Q16	GND	R16	GND	-	-
-	-	-	1	-	1	-	1	-	-
N18	NC	P18	NC	Q18	NC	R18	NC	S18	NC
N19	NC	P19	SW26_P	Q19	NC	R19	SW28_P	S19	NC
N20	SW25_P	P20	NC	Q20	SW27_P	R20	NC	S20	SW29_P
N21	NC	P21	SW26_A	Q21	NC	R21	SW28_A	S21	NC
N22	SW25_A	P22	NC	Q22	SW27_A	R22	NC	S22	SW29_A

No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name
T1	SW49_A	U1	NC	V1	VDD	W1	BANK3	X1	BANK2
T2	NC	U2	SW48_A	V2	GND	W2	CLR	X2	CLKOUT_EN
T3	SW49_P	U3	NC	V3	R_ENB	W3	RGND	Х3	GND
T4	NC	U4	SW47_P	V4	NC	W4	SW47_A	X4	NC
T5	SW48_P	U5	NC	V5	SW46_P	W5	NC	X5	SW46_A
T6	NC	U6	SW45_P	V6	NC	W6	SW45_A	X6	NC
T7	NC	U7	NC	V7	SW44_P	W7	NC	X7	SW44_A
T8	NC	U8	SW43_P	V8	NC	W8	SW43_A	X8	NC
T9	NC	U9	NC	V9	SW42_P	W9	NC	X9	SW42_A
T10	NC	U10	SW41_P	V10	NC	W10	SW41_A	X10	NC
T11	NC	U11	NC	V11	SW40_P	W11	NC	X11	SW40_A
T12	NC	U12	SW39_P	V12	NC	W12	SW39_A	X12	NC
T13	NC	U13	NC	V13	SW38_P	W13	NC	X13	SW38_A
T14	NC	U14	SW37_P	V14	NC	W14	SW37_A	X14	NC
T15	NC	U15	NC	V15	SW36_P	W15	NC	X15	SW36_A
T16	NC	U16	SW35_P	V16	NC	W16	SW35_A	X16	NC
T17	NC	U17	NC	V17	SW34_P	W17	NC	X17	SW34_A
T18	NC	U18	SW33_P	V18	NC	W18	SW33_A	X18	NC
T19	SW30_P	U19	NC	V19	SW32_P	W19	NC	X19	SW32_A
T20	NC	U20	SW31_P	V20	RGND	W20	BANK0	X20	NC
T21	SW30_A	U21	NC	V21	GND	W21	GND	X21	BANK1
T22	NC	U22	SW31_A	V22	GND	W22	VDD	X22	BANK_EN

TOP VIEW

	Α	В	С	D	E	F	G	Н	J	K	L	М	N	Р	Q	R	S	Т	U	V	W	Х
1	DIN	CLKIN	VLL	SW63_A	NC	SW61_A	NC	SW59_A	NC	SW57_A	NC	SW55_A	NC	SW53_A	NC	SW51_A	NC	SW49_A	NC	VDD	BANK3	BANK2
2	LEB	RESET	VDD	NC	SW62_A	NC	SW60_A	NC	SW58_A	NC	SW56_A	NC	SW54_A	NC	SW52_A	NC	SW50_A	NC	SW48_A	GND	CLR	CLKOUT_ EN
3	GND	GND	RGND	SW63_P	NC	SW61_P	NC	SW59_P	NC	SW57_P	NC	SW55_P	NC	SW53_P	NC	SW51_P	NC	SW49_P	NC	R_ENB	RGND	GND
4	SW0_A	NC	SW0_P	NC	SW62_P	NC	SW60_P	NC	SW58_P	NC	SW56_P	NC	SW54_P	NC	SW52_P	NC	SW50_P	NC	SW47_P	NC	SW47_A	NC
5	NC	SW1_A	NC	SW1_P	NC	SW48_P	NC	SW46_P	NC	SW46_A												
6	SW2_A	NC	SW2_P	NC	NC	NC		-	-	-	-		-	-	-	-	i	NC	SW45_P	NC	SW45_A	NC
7	NC	SW3_A	NC	SW3_P	NC	1	GND	i	NC	NC	SW44_P	NC	SW44_A									
8	SW4_A	NC	SW4_P	NC	NC	-	GND	-	NC	SW43_P	NC	SW43_A	NC									
9	NC	SW5_A	NC	SW5_P	NC	-	GND	-	NC	NC	SW42_P	NC	SW42_A									
10	SW6_A	NC	SW6_P	NC	NC	-	GND	-	NC	SW41_P	NC	SW41_A	NC									
11	NC	SW7_A	NC	SW7_P	NC	-	GND	-	NC	NC	SW40_P	NC	SW40_A									
12	SW8_A	NC	SW8_P	NC	NC	-	GND	ı	NC	SW39_P	NC	SW39_A	NC									
13	NC	SW9_A	NC	SW9_P	NC	-	GND	ı	NC	NC	SW38_P	NC	SW38_A									
14	SW10_A	NC	SW10_P	NC	NC	-	GND	ı	NC	SW37_P	NC	SW37_A	NC									
15	NC	SW11_A	NC	SW11_P	NC	-	GND	i	NC	NC	SW36_P	NC	SW36_A									
16	SW12_A	NC	SW12_P	NC	NC	-	GND	ı	NC	SW35_P	NC	SW35_A	NC									
17	NC	SW13_A	NC	SW13_P	NC	-	-	-	-	·	-	-	-	-	-	-	i	NC	NC	SW34_P	NC	SW34_A
18	SW14_A	NC	SW14_P	NC	SW16_P	NC	SW33_P	NC	SW33_A	NC												
19	NC	SW15_A	NC	SW15_P	NC	SW18_P	NC	SW20_P	NC	SW22_P	NC	SW24_P	NC	SW26_P	NC	SW28_P	NC	SW30_P	NC	SW32_P	NC	SW32_A
20	VLL	NC	RGND	NC	SW17_P	NC	SW19_P	NC	SW21_P	NC	SW23_P	NC	SW25_P	NC	SW27_P	NC	SW29_P	NC	SW31_P	RGND	BANK0	NC
21	GND	THP	GND	SW16_A	NC	SW18_A	NC	SW20_A	NC	SW22_A	NC	SW24_A	NC	SW26_A	NC	SW28_A	NC	SW30_A	NC	GND	GND	BANK1
22	DOUT	CLKOUT	VDD	NC	SW17_A	NC	SW19_A	NC	SW21_A	NC	SW23_A	NC	SW25_A	NC	SW27_A	NC	SW29_A	NC	SW31_A	GND	VDD	BANK_EN

■ Package

Package Name	Dimension	Tray	Marking	Land	Packing
BGA-441(1515)A	RA441-A-P-S1	RA441-A-T-SD	RA441-A-M-SD	RA441-A-L-SD	RA441-A-K-SD

■ Storage, Mounting

1. Storage conditions

- 1.1 The storage location should be kept at 5 to 35°C and 40 to 70% relative humidity. Keeping in a dry box is recommended. Moisture-proof property is assured for 12 months from delivery date for sealed moisture-proof packing, while it is guaranteed for 7 days from unpacked date under the condition above.
- 1. 2 When the storage conditions do not conform to those above or other conditions occur indicating moisture exposure, the ICs should be dried to avoid package cracks. A baking process at 125°C lasting for 24 hours results in sufficient dehumidification. The baking is not allowed more than twice, and the ICs should be mounted within 7 days after initial baking or within 10 days of total exposure after the second dehumidification.

2. Reflow soldering

The temperature rise may be different in the resin and a terminal part due to the reflow soldering. It is necessary to check the package surface temperature (resin) before setting the temperature profile. **Figure 1** shows the resistance to soldering heat condition for package (Reflow method). Confirm the heat resistance of the package shown below. (Based on JEDEC J-STD-020).

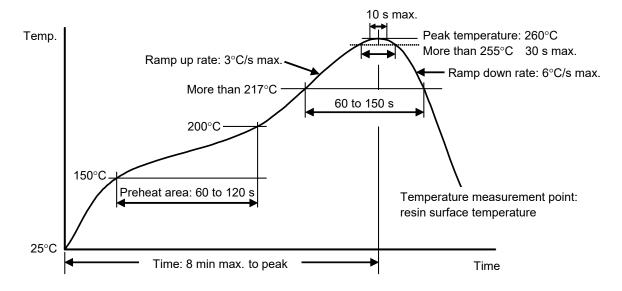


Figure 1 Resistance to Soldering Heat Condition for Package (Reflow Method)

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LOW CHARGE INJECTION 64-CHANNEL 6 Ω HIGH-VOLTAGE ANALOG SWITCHES Rev.1.0 $_{00}$ S-UM6532

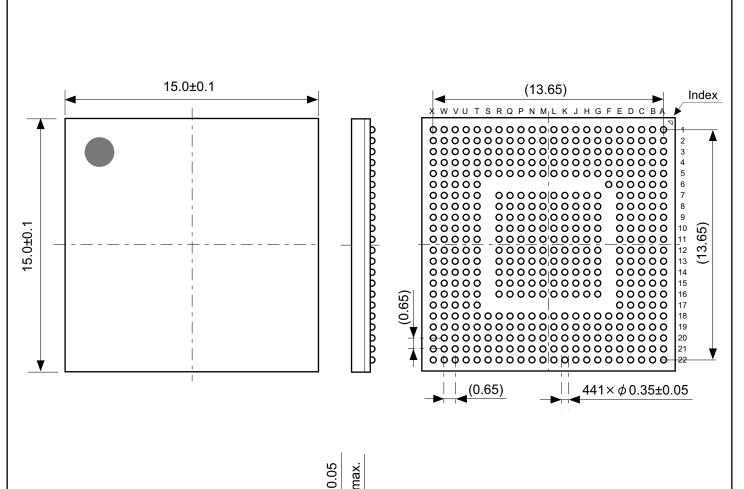
■ Important Notice

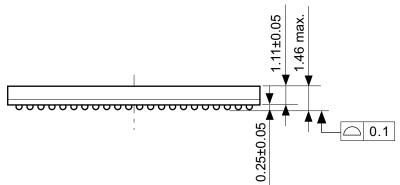
- 1. ABLIC Inc. warrants performance of its hardware products (hereinafter called "products") to the specifications applicable at the time of sale in accordance with the Product Specification. Testing and other quality control techniques are utilized to the extent ABLIC Inc. needs to meet specifications described in the Product Specification. Specific testing of all parameters of each device is not necessarily performed, except those mandated by related laws and/or regulations.
- 2. Should any claim be made within one month of product delivery about products' failure to meet performance described in the Product Specification, all the products in relevant lot(s) shall be re-tested and re-delivered. Products delivered more than one month before such claim shall not be counted for such response.
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LOW CHARGE INJECTION 64-CHANNEL 6 Ω HIGH-VOLTAGE ANALOG SWITCHES S-UM6532 Rev.1.0 $_{_00}$

■ Cautions

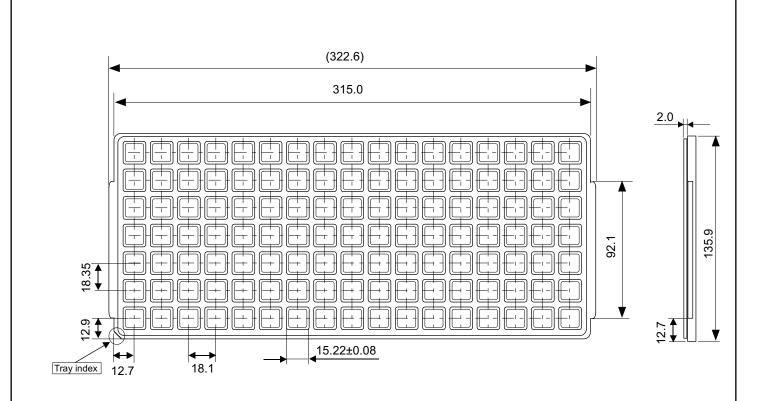
- 1. Customers are advised to follow the cautions below to protect products from damage caused by electrical static discharge (ESD).
 - **1.1** Material of container or any device to carry products should be free from ESD, which may be caused by vibration while transportation. It is recommended that electric-conductive container or aluminum sheet be used as an effective countermeasure.
 - **1.2** Those that touch products, such as work platform, machine, or measurement/test equipment, should be grounded.
 - 1.3 Those who deal with products should be grounded through a large series impedance around $100k\Omega$ to $1M\Omega$.
 - **1.4** Prevent friction with other materials made with high polymer.
 - **1.5** Prevent vibration or friction when carrying the printed circuit board (PCB) where products are mounted. To short circuit terminals is a recommended countermeasure to keep the same electric potential on the PCB.
 - **1.6** Avoid dealing with or storing products in an extremely arid environment.
- 2. "Absolute maximum ratings" should never be exceeded during use regardless of any change in external conditions. Otherwise, products may be damaged or destroyed. In no event shall ABLIC Inc. be liable for any failure in products or any secondary damage resulting from use at a value exceeding the absolute maximum ratings.
- 3. Products may experience failures due to accident or unexpected surge voltages. Accordingly, adopt safe design features, such as redundancy or prevention of erroneous action, to avoid extensive damage in the event of a failure. (If a semiconductor device fails, there may be cases in which the semiconductor device, wiring or wiring pattern will emit smoke or cause a fire or in which the semiconductor device will burst.)
- 4. Products may experience failures or malfunction in poor surroundings, such as electrical leakage in products due to long-term use in high humidity, malfunctioning or permanent damage due to chemical reaction of products in corrosive environment or due to discharge by strongly charged object near products or due to excessive mechanical shock. To use products in radiation environment is not assumed. To use products near material easy to ignite may cause a fire due to its flammable package. Avoid using products in such environment or take appropriate countermeasures depending on the environment.
- 5. Products are not designed, manufactured, or warranted to be suitable for use where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, life-support-related medical equipment, fuel control equipment and various kinds of safety equipment). Inclusion of products in such application shall be fully at the risk of customers. ABLIC Inc. assumes no liability for applications assistance, customer product design, or performance.

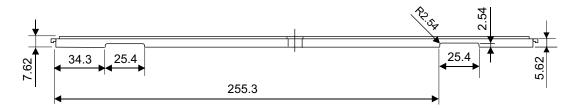


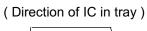


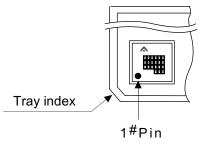
No. RA441-A-P-S1-1.0

TITLE	BGA441-A-PKG Dimensions (S-UM6532)				
No.	RA441-A-P-S1-1.0				
ANGLE	♦ €				
UNIT	mm				
ABLIC Inc.					



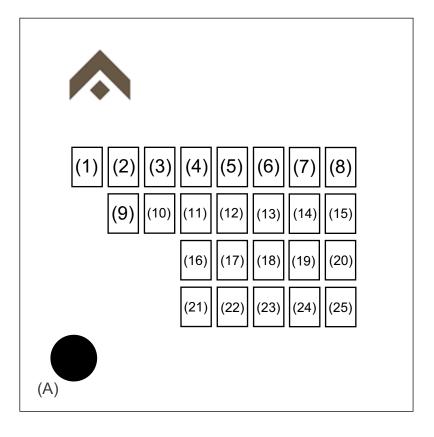






No. RA441-A-T-SD-1.0

TITLE	BGA441-A-Tray				
No.	RA441-A-T-SD-1.0				
ANGLE		QTY.	119		
UNIT	mm				
ABLIC Inc.					



(1) to (10) : Product code

(11), (12) : Quality control code

(13) : Year of assembly

(14) : Month of assembly

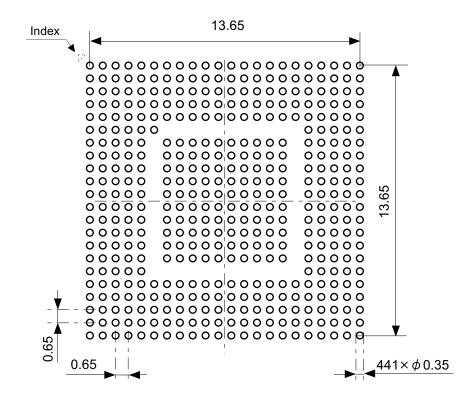
(15) : Week of assembly

(16) to (25): Quality control code

(A) : 1-pin mark

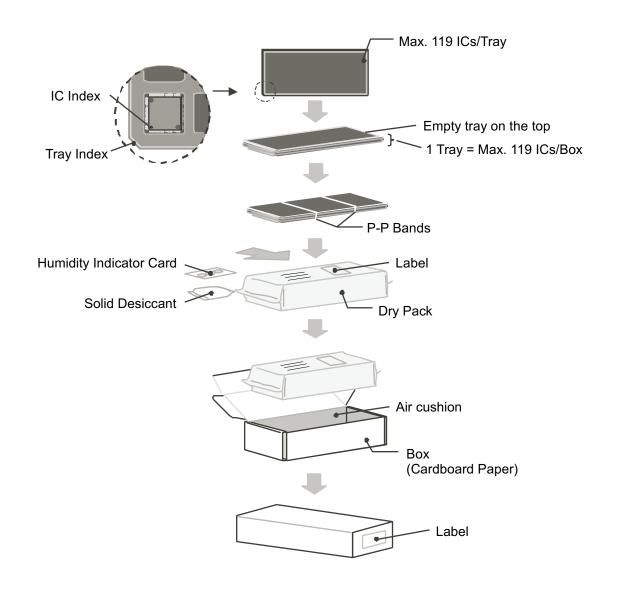
No. RA441-A-M-SD-1.0

TITLE	BGA44	41-A-M	arkings		
No.	RA441-A-M-SD-1.0				
ANGLE					
UNIT		TYPE	LASER		
ABLIC Inc.					



No. RA441-A-L-SD-1.0

TITLE	BGA441-A -Land Recommendation				
No.	RA441-A-L-SD-1.0				
ANGLE					
UNIT	mm				
ABLIC Inc.					



No. RA441-A-K-SD-1.0

TITLE	BGA441-A -Packing Procedure			
No.	RA441-A-K-SD-1.0			
ANGLE				
UNIT				
ABLIC Inc.				

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